

# SPE05M50T-A/C

## 主要参数 MAIN CHARACTERISTICS

500V/5A 3相全桥驱动	
$V_{DSS}$	500V
$I_D$	2.4A
$I_{DM}$	5A
$V_{ISO}$	1500V

### 用途

- 冰箱压缩机
- 油烟机
- 风扇
- 空气净化器
- 洗碗机水泵

### APPLICATIONS

- Refrigerator compressor
- Lampblack machine
- Electric fan
- Air purifier
- Dishwasher pump

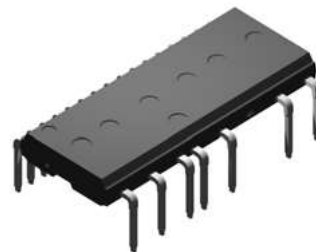
### 产品特性

- 信号高电平有效, 兼容 3.3V 和 5V 的 MCU
- 下臂 MOSFET 源极输出
- 内置自举二极管
- 内置防直通保护
- 内置欠压保护
- 内部集成温度检测输出
- 绝缘耐压 1500V

### FEATURES

- Signal high level valid, compatible with 3.3v and 5V MCU
- Lower arm MOSFET source electrode output
- Built-in bootstrap diode
- Built-in straight through protection
- Built-in undervoltage protection
- Internal integrated temperature detection output
- Resistant to high voltage 1500V

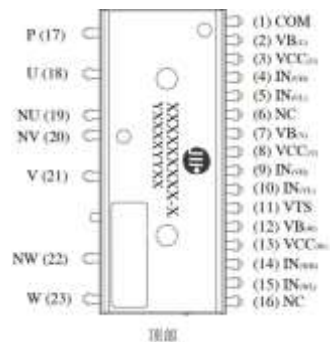
## 封装 Package



DIP23-FP



SOP23-FP



PIN1-PIN23

## 订货信息 ORDER MESSAGE

订货料号 Order number	产品信息 Product information			
	无卤-条管 Halogen-Free-Tube	无卤-编带 Halogen-Free-Reel	印记 Marking	封装 Package
2A01-0505	SPE05M50T-A	N/A	SPE05M50T-A	DIP23-FP
2A01-0577	SPE05M50T-C	N/A	SPE05M50T-C	SOP23-FP

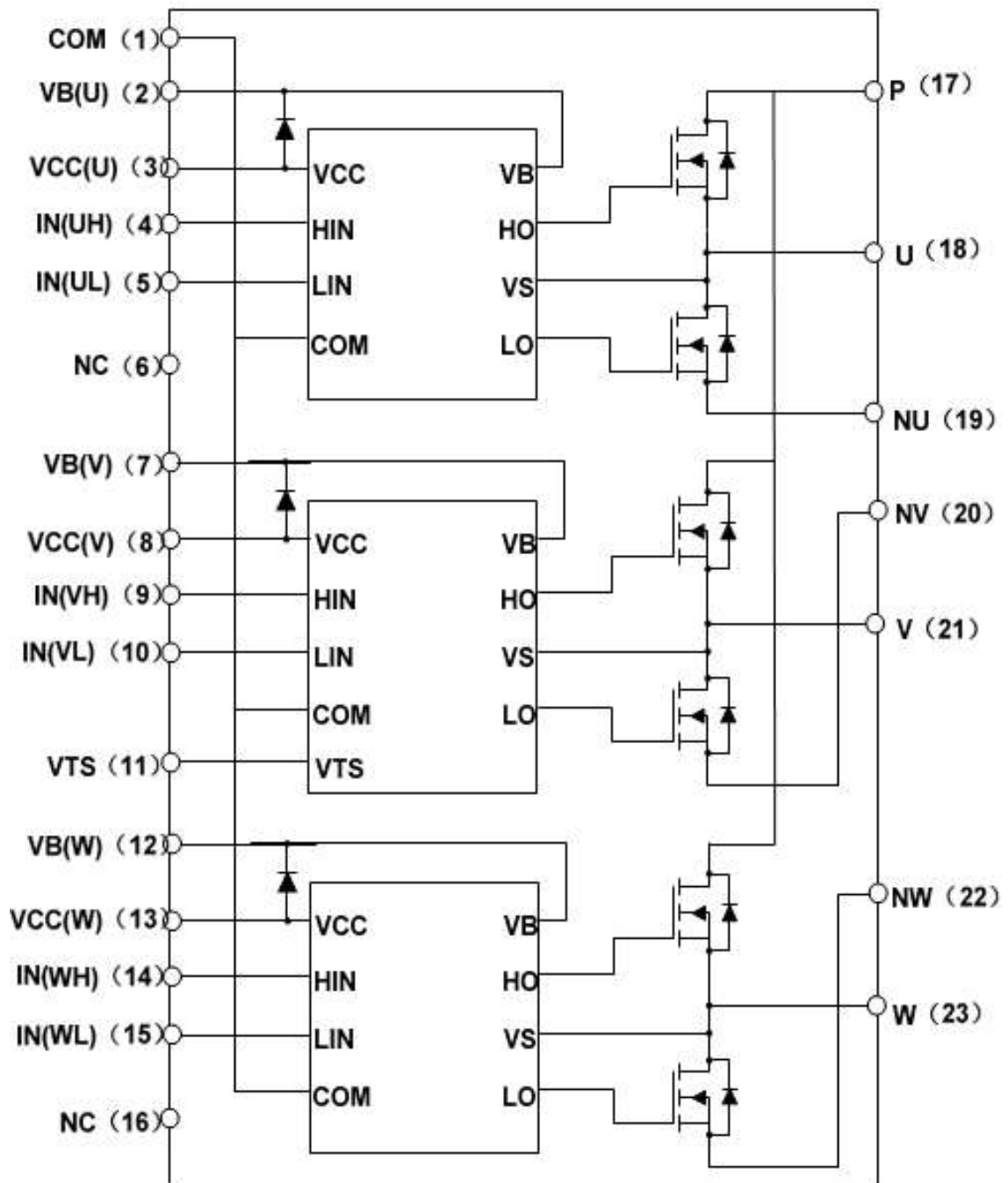


图 1：模块内部电路示意图

Fig 1: Internal circuit

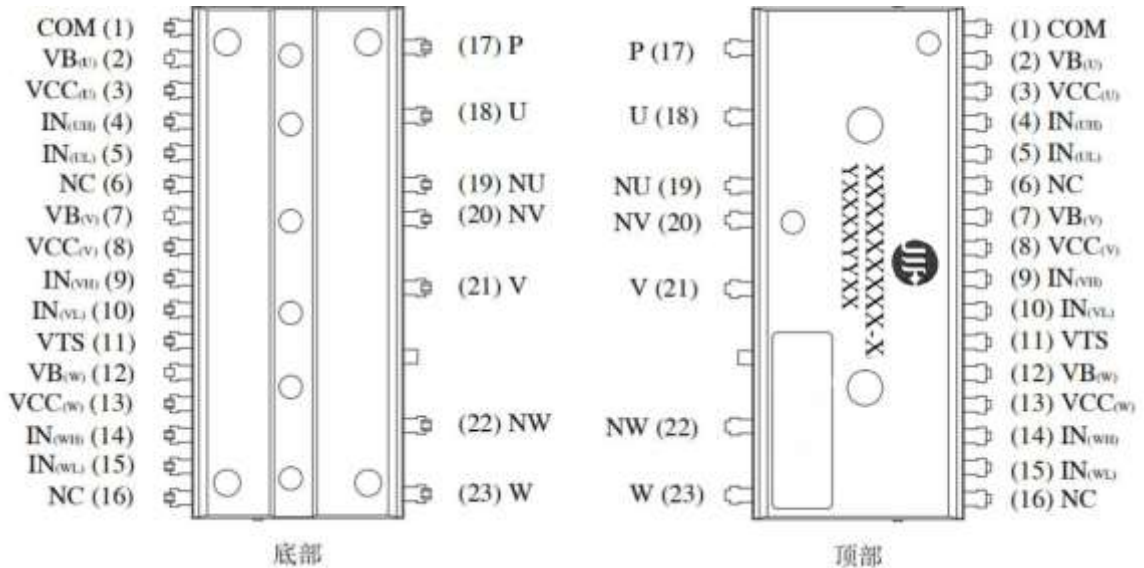


图 2: 模块引脚分布示意图  
Fig 2: Distribution of pin

引脚编号 Number	引脚名称 Name	引脚描述 Description
1	COM	控制电源 GND 端子 IC Common Supply Ground
2	VB(U)	U 相上臂驱动电源端子 Bias Voltage for U-Phase High-Side MOSFET Driving
3	VCC(U)	U 控制电源端子 Bias Voltage for U-Phase IC and Low-Side MOSFET Driving
4	IN(UH)	U 相上臂控制信号输入端子 Signal Input for U-Phase High-Side
5	IN(UL)	U 相下臂控制信号输入端子 Signal Input for U-Phase Low-Side
6	NC	无连接 No Connection
7	VB(V)	V 相上臂驱动电源端子 Bias Voltage for V-Phase High Side MOSFET Driving
8	VCC(V)	V 控制电源端子 Bias Voltage for V-Phase IC and Low Side MOSFET Driving
9	IN(VH)	V 相上臂控制信号输入端子 Signal Input for V-Phase High-Side
10	IN(VL)	V 相下臂控制信号输入端子 Signal Input for V-Phase Low-Side
11	VTS	HVIC 温度输出 Output for HVIC Temperature Sensing
12	VB(W)	W 相上臂驱动电源端子 Bias Voltage for W-Phase High-Side MOSFET Driving
13	VCC(W)	W 控制电源端子 Bias Voltage for W-Phase IC and Low-Side MOSFET Driving
14	IN(WH)	W 相上臂控制信号输入端子 Signal Input for W-Phase High-Side
15	IN(WL)	W 相下臂控制信号输入端子 Signal Input for W-Phase Low-Side
16	NC	无连接 No Connection
17	P	逆变器直流输入端子 Positive DC-Link Input
18	U	U 相输出端子 Output for U-Phase & Bias Voltage Ground for High-Side MOSFET Driving
19	NU	U 相下臂 MOSFET 源极端子 Negative DC-Link Input for U-Phase
20	NV	V 相下臂 MOSFET 源极端子 Negative DC-Link Input for V-Phase
21	V	V 相输出端子 Output for V-Phase & Bias Voltage Ground for High-Side MOSFET Driving
22	NW	W 相下臂 MOSFET 源极端子 Negative DC-Link Input for W-Phase
23	W	W 相输出端子 Output for W Phase & Bias Voltage Ground for High-Side MOSFET Driving

图 3: 模块引脚功能定义表  
Fig 3: Pin function

最大额定值 (T<sub>j</sub>= 25°C, 除非特殊说明)Absolute Maximum Ratings (T<sub>j</sub>= 25°C, Unless otherwise Specified)

## 逆变部分 Inverter Part

记号 Symbol	参数 Parameter	条件 Condition	额定值 Ratings	单位 Units
V <sub>DSS</sub>	漏-源电压 Drain-Source Voltage of Each MOSFET	/	500	V
I <sub>D</sub>	漏极连续电流 Each MOSFET Current, Continuous	T <sub>c</sub> =25°C (T <sub>c</sub> 测量参考图 6) T <sub>c</sub> =25°C (T <sub>c</sub> refer to Fig:6)	2.4	A
I <sub>DM</sub>	漏极电流 (峰值) Each MOSFET Pulse Current, Peak	T <sub>c</sub> =25°C, 脉冲宽度小于 100us T <sub>c</sub> =25°C, less than 100us	5	A
I <sub>Drms</sub>	漏极电流 (有效值) Each MOSFET Current, Rms	T <sub>c</sub> =25°C, F <sub>PWM</sub> <20KHz	1.7	Arms
P <sub>D</sub>	最大功耗 Maximum Power Dissipation	T <sub>c</sub> =25°C, 每个 MOSFET T <sub>c</sub> =25°C, For Each MOSFET	16	W

## 控制部分 Control Part

记号 Symbol	参数 Parameter	条件 Condition	额定值 Ratings	单位 Units
V <sub>CC</sub>	控制电源电压 Control Supply Voltage	V <sub>CC</sub> -COM 之间 Applied between VCC and COM	20	V
V <sub>BS</sub>	高侧控制电压 High-side Bias Voltage	VB-VS 之间 Applied between VB and VS	20	V
V <sub>IN</sub>	输入信号电压 Input Signal Voltage	V <sub>IN</sub> -COM 之间 Applied between VIN and COM	-0.3~V <sub>CC</sub> +0.3	V

## 整个系统 Total System

记号 Symbol	参数 Parameter	条件 Condition	额定值 Ratings	单位 Units
T <sub>j</sub>	结温 Operating Junction Temperature	/	-40~150	°C
T <sub>STG</sub>	贮存温度 Storage Temperature	T <sub>c</sub> =25°C	-40~125	°C
V <sub>ISO</sub>	绝缘耐压 Isolation Voltage	60Hz, 正弦, AC 1 分钟, 连接管脚到散热器 60Hz, Sinusoidal, AC 1 min, between pins and heat-sink plate	1500	V

备注 1: 为了确保 IPM 正常工作, 模块的结温应该小于 150°C (@T<sub>c</sub> ≤ 100° C)。NOTE 1: To insure safe operation of the IPM, the average junction temperature should be limited to T<sub>J</sub> ≤ 150° C (@T<sub>c</sub> ≤ 100° C).

## 热阻 Thermal Resistance

记号 Symbol	参数 Parameter	条件 Condition	额定值 Ratings	单位 Units
R <sub>th(j-c)</sub>	结到外壳的热阻 Junction to Case Thermal resistance	每个 MOSFET For Each MOSFET	7.8	°C/W

电气特性 (T<sub>j</sub>=25°C, 除非特殊说明)Electrical Characteristics (T<sub>J</sub>=25°C, Unless Otherwise Specified)

## 逆变部分 Inverter Part

记号 Symbol	参数 Parameter	条件 Condition	最小值 Min.	典型值 Typ.	最大值 Max.	单位 Unit
BV <sub>DSS</sub>	漏-源击穿电压 Drain-Source Breakdown Voltage	V <sub>IN</sub> =0V, I <sub>D</sub> =1mA(备注2) (Note2)	500	-	-	V
I <sub>DSS</sub>	零栅极电压漏极电流 Zero Gate Voltage Drain Current	V <sub>IN</sub> =0V, V <sub>DS</sub> =500V	-	-	1	mA
V <sub>SD</sub>	源-漏二极管正向电压 Drain-Source Diode Forward Voltage	V <sub>CC</sub> =V <sub>BS</sub> =15V, V <sub>IN</sub> =0V, I <sub>D</sub> =-1.2A	-	0.9	-	V
R <sub>DS(on)</sub>	漏-源导通电阻 Drain-Source Turn-On Resistance	V <sub>CC</sub> =V <sub>BS</sub> =15V, V <sub>IN</sub> =5V, I <sub>D</sub> =1.2A	-	1.25	-	ohm
t <sub>ON</sub>	开关时间 Switching Times	V <sub>PN</sub> =300V, V <sub>CC</sub> =V <sub>BS</sub> =15V, I <sub>D</sub> =2.4A, V <sub>IN</sub> =0/5V, 感性负载(Inductive Load) L=3mH (备注3) (Note3)	-	580	-	nS
t <sub>OFF</sub>			-	780	-	nS
t <sub>rr</sub>			-	150	-	nS
E <sub>ON</sub>			-	110	-	uJ
E <sub>OFF</sub>			-	8	-	uJ
R <sub>BSOA</sub>	反向偏置安全工作区 Reverse Bias Safe Operating Area	V <sub>PN</sub> =400V, V <sub>CC</sub> =V <sub>BS</sub> =15V, I <sub>D</sub> =I <sub>DP</sub> , V <sub>DS</sub> =BV <sub>DSS</sub> , T=150°C	全直角 Full Square			

备注 2: BV<sub>DSS</sub> 是单个 MOSFET 漏源最大电压。V<sub>PN</sub> 应小于该值, 考虑到杂散电感, V<sub>DS</sub> 在任何情况下都不应超过 BV<sub>DSS</sub>。

NOTE 2: BV<sub>DSS</sub> is the absolute maximum voltage rating between drain and source terminal of each FRFET inside SPM®. V<sub>PN</sub> should be sufficiently less than this value considering the effect of the stray inductance so that V<sub>DS</sub> should not exceed BV<sub>DSS</sub> in any case.

备注 3: t<sub>ON</sub> 和 t<sub>OFF</sub> 包含驱动 IC 传输延迟。列表值是在实验条件下测得, 不同的 PCB 及连线会改变数值。请参考图 4 的开关时间定义。

NOTE 3: t<sub>ON</sub> and t<sub>OFF</sub> include the propagation delay time of the internal drive IC. Listed values are measured at the laboratory test condition, and they can be different according to the field applications due to the effect of different printed circuit boards and wirings. Please see Fig 4 for the switching time definition.

## 控制部分 Control Part

记号 Symbol	参数 Parameter	条件 Condition	最小值 Min.	典型值 Typ.	最大值 Max.	单位 Unit
I <sub>QCC</sub>	V <sub>CC</sub> 静态电流 Quiescent V <sub>CC</sub> Supply Current	V <sub>CC</sub> =15V V <sub>IN</sub> =5V	V <sub>CC</sub> -COM 之间 Applied between V <sub>CC</sub> and COM		600	uA
I <sub>QB</sub>	V <sub>BS</sub> 静态电流 Quiescent V <sub>BS</sub> Supply Current	V <sub>DB</sub> =15V V <sub>IN</sub> =5V	V <sub>B</sub> (U)-U, V <sub>B</sub> (V)-V, V <sub>B</sub> (W)-W 之间 Applied between V <sub>B</sub> (U)-U, V <sub>B</sub> (V)-V, V <sub>B</sub> (W)-W		210	uA
UV <sub>CCD</sub>	低侧欠压保护 Low-Side Under-Voltage Protection	检测电平 V <sub>CC</sub> Under-Voltage Protection Detection Level		7.4	8.2	9.4
UV <sub>CCR</sub>		复位电平 V <sub>CC</sub> Under-Voltage Protection Reset Level		8.0	8.9	9.8
UV <sub>BSD</sub>	高侧欠压保护 High-Side Under-Voltage Protection	检测电平 V <sub>BS</sub> Under-Voltage Protection Detection Level		7.4	8.2	9.4
UV <sub>BSR</sub>		复位电平 V <sub>BS</sub> Under-Voltage Protection Reset Level		8.0	8.9	9.8
V <sub>TS</sub>	HVIC 温度检测输出	V <sub>CC</sub> =15V, T <sub>HVIC</sub> =25°C (图 5) (Fig5)		0.6	0.8	1.3



	HVIC Temperature Sensing Voltage Output					
$V_{IH}$	输入开启阈值电压 ON Threshold Voltage	逻辑高电平, 加在 $V_{IN}$ 与 COM 之间 Logic HIGH Level, Applied between $V_{IN}$ and COM	-	-	2.9	V
$V_{IL}$	输入关闭阈值电压 OFF Threshold Voltage	逻辑低电平, 加在 $V_{IN}$ 与 COM 之间 Logic Low Level, Applied between $V_{IN}$ and COM	0.8	-	-	V
$V_F(BSD)$	自举二极管导通压降 BSD Forward voltage	$I_F=10mA, T_C=25^\circ C$	-	3.5	8	V

**推荐工作条件 Recommended Operating Conditions**

记号 Symbol	参数 Parameter	记号 Symbol	最小值 Min.	典型值 Typ.	最大值 Max.	单位 Unit
$V_{PN}$	电源电压 Supply Voltage	P-N 之间 Applied between P and N	-	300	400	V
$V_{CC}$	控制电源电压 Control Supply Voltage	$V_{CC}$ -COM 之间 Applied between $V_{CC}$ and COM	13.5	15.0	16.5	V
$V_{BS}$	高侧控制电源电压 High-Side Bias Voltage	$V_B$ - $V_S$ 之间 Applied between $V_B$ and $V_S$	13.5	15.0	16.5	V
$V_{IN(ON)}$	输入开启阈值电压 Input ON Threshold Voltage	$V_{IN}$ -COM 之间 Applied between $V_{IN}$ and COM	3.0	-	$V_{CC}$	V
$V_{IN(OFF)}$	输入关闭阈值电压 Input OFF Threshold Voltage		0	-	0.6	V
$t_{dead}$	死区时间 Blanking Time for Preventing Arm-Shor	$V_{CC}=V_{BS}=13.5\sim 16.5V, T_j<150^\circ C$	1.0	-	-	us
$F_{PWM}$	PWM 开关频率 PWM Switching Frequency	$T_j<150^\circ C$	-	15	-	KHz

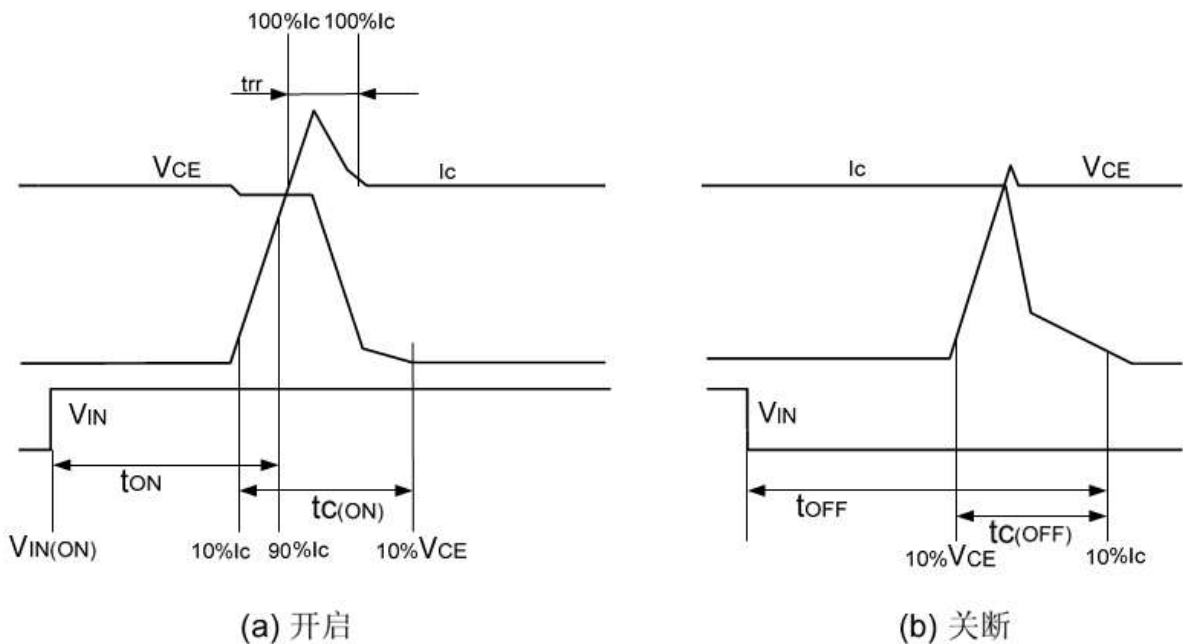


图 4: 开关时间定义  
Fig 4: Switching Time Definition

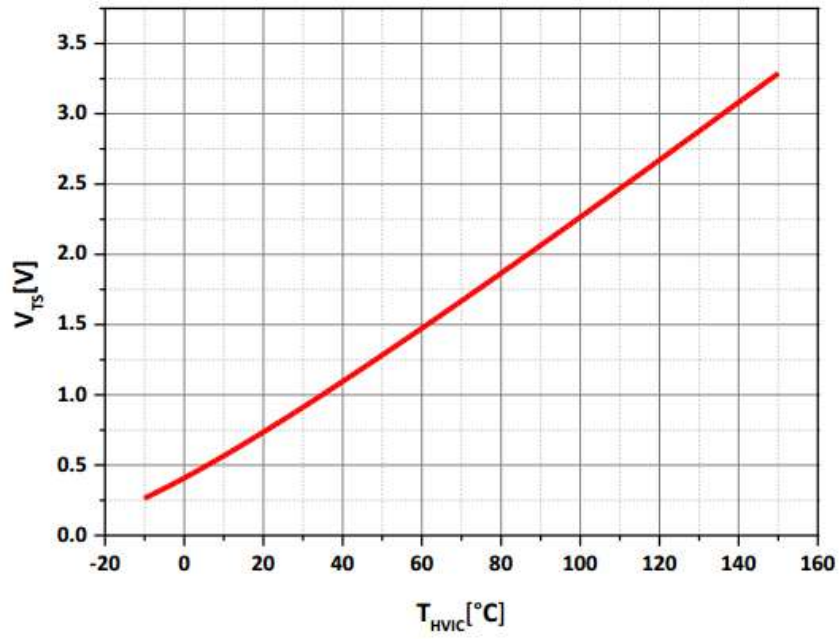


图 5: HVIC 温度检测输出温度—电压曲线

Fig 5: Curves of HVIC Temperature detection-voltage curve

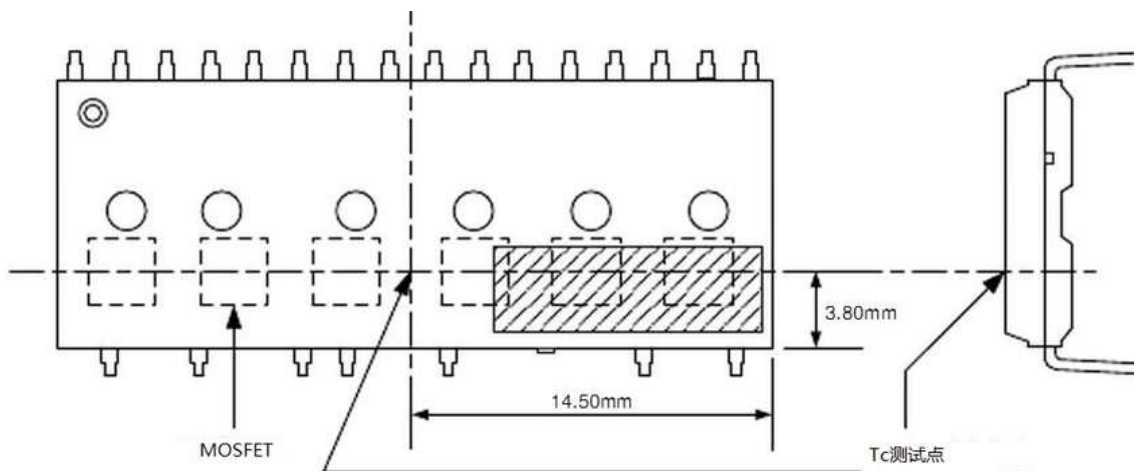


图 6: 壳温 Tc 测试点

Fig 6: Case Temperature Measurement

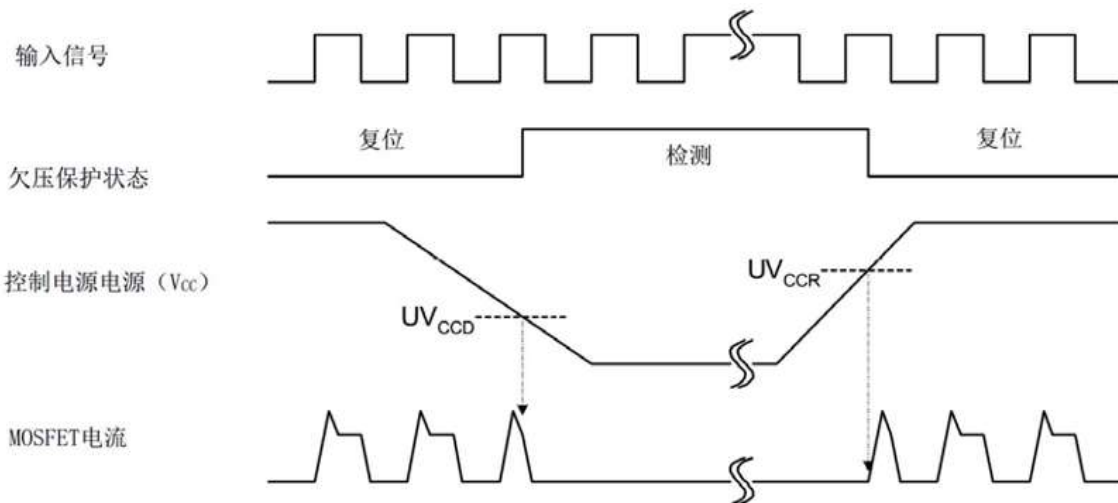


图 7: 欠压保护时序图(低侧)

Fig 7: Undervoltage protection sequence diagram (low side)

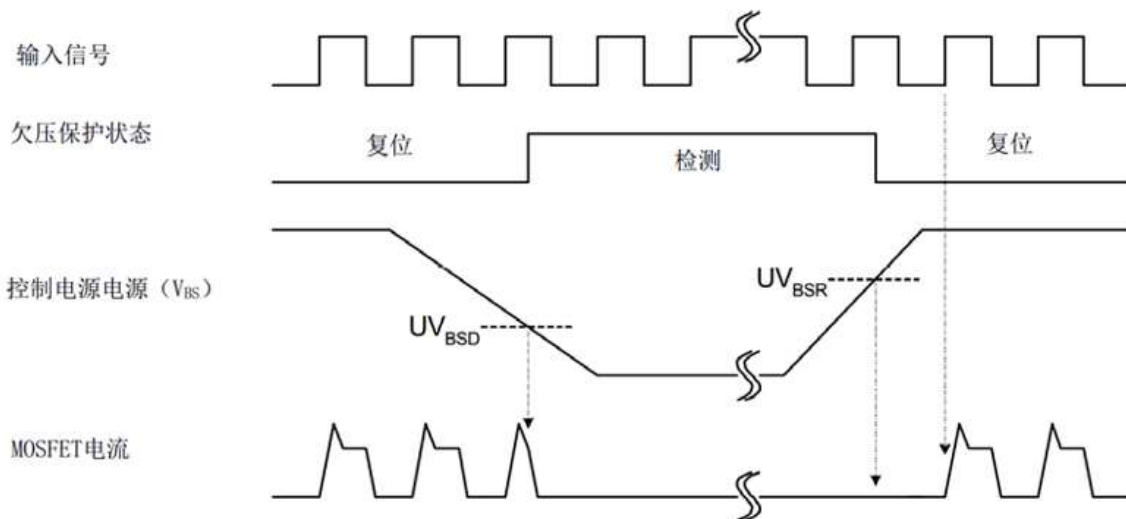
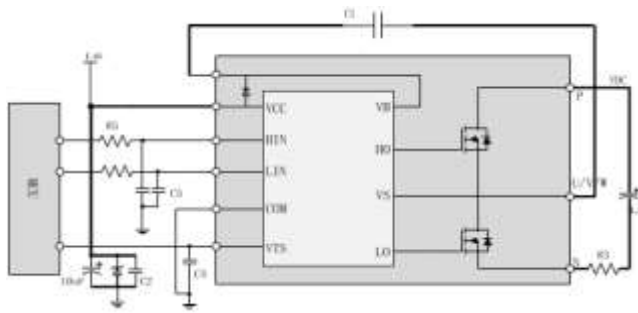


图 8: 欠压保护时序图(高侧)

Fig 8: Undervoltage protection sequence diagram (High side)



应用电路 Application Circuit



HIN	LIN	逆变器输出	备注
0	0	高阻	上下桥MOS关闭
0	1	0	下桥MOS开通
1	0	VDC	上桥MOS开通
1	1	禁止	直通
开路	开路	高阻	上下桥MOS关闭

图 9: MCU 接口和自举推荐电路

Fig 9: Recommended CPU Interface and Bootstrap Circuit with Parameters

备注 4: 自举电路的元器件参数要根据 PWM 周期而定, 以 15kHz 开关频率为例: C1=C2=4.7uF。

NOTE 4: Parameters for bootstrap circuit elements are dependent on PWM algorithm. For 15 kHz of switching frequency, typical example of parameters is an example of: C1=C2=4.7uF。

备注 5: 在模块的每个输入端和 MCU 输出端之间加入 RC 去耦电路, 如 R5、C5 和高频滤波电容, 如: C4, 防止干扰噪声引起的信号失真。

NOTE 5: RC coupling (R5 and C5) and C4 at each input of SPM® and MCU may be used to prevent improper signal due to surge noise. Signal input of SPM® is compatible with standard CMOS or LSTTL outputs.

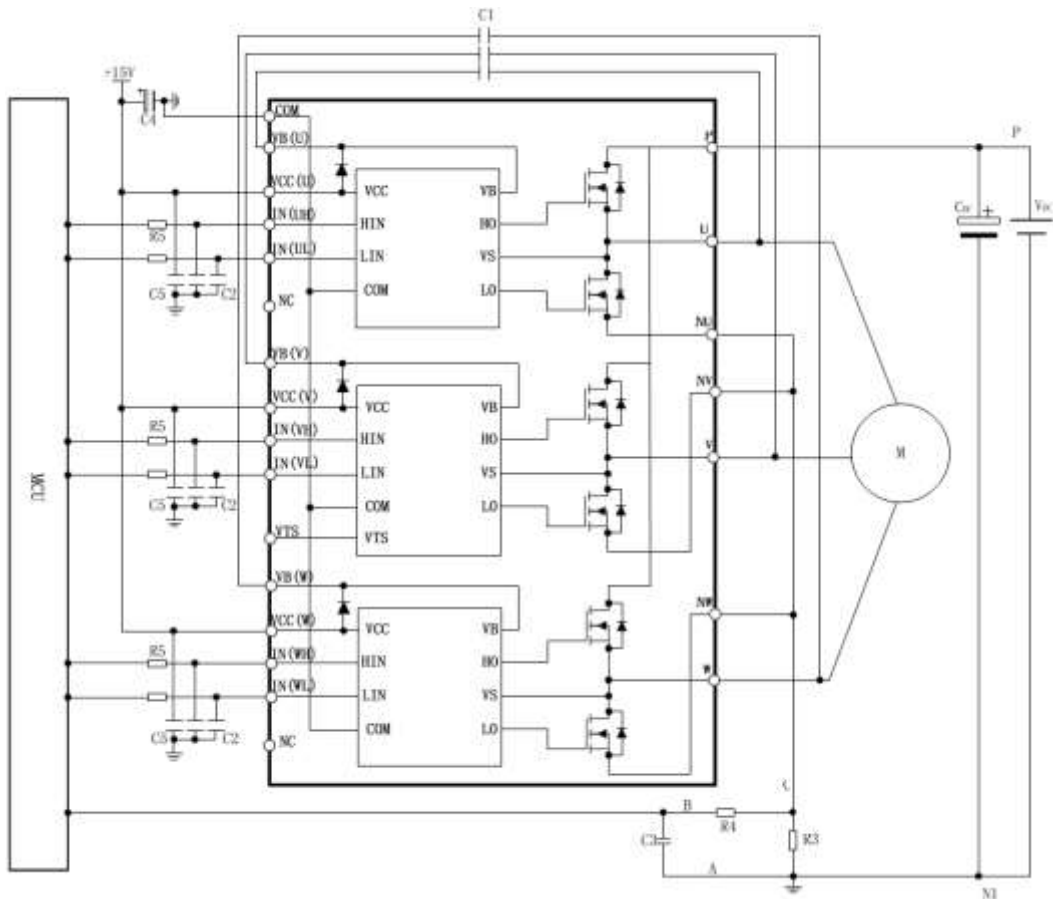


图 10: 典型应用电路图

Fig 10: Example of Application Circuit



备注 6: 输入驱动高有效; IC 内部集成有一个 500K (典型值) 下拉电阻; 为防止发生误动作, 输入布线应尽可能短; 当用 RC 去耦线路时, 须确保输入信号达到开启和关断阈值电压范围。

NOTE 6: Input drive is High-Active type. There is a 500k $\Omega$  (typ.) pull-down resistor integrated in the IC input circuit. To prevent malfunction, the wiring of each input should be as short as possible. When using RC coupling circuit, make sure the input signal level meet the turn-on and turn-off threshold voltage.

备注 7: 由于 R3 位于 MOSFET 源极与 COM 之间, R3 的压降会影响到下侧 MOSFET 的开关特性以及自举电路的特性因此 R3 的稳态压降应小于 1V。

NOTE 7: The voltage drop across R3 affects the low side switching performance and the bootstrap characteristics since it is placed between COM and the source terminal of the low side MOSFET. For this reason, the voltage drop across R3 should be less than 1V in the steady-state.

备注 8: 由于模块内置了专用 HVIC, 其控制端子可与 CPU 端子直接相连, 而不需要任何光耦或变压器等隔离电路。

NOTE 8: Thanks for HVIC inside modules, direct coupling to MCU without any opto-coupler or transformer isolation is possible.

备注 9: 自举电路负极应直接连接到 U、V、W 的端。

NOTE 9: Bootstrap negative electrodes should be connected to U, V, W terminals directly and separated from the main output wires.

备注 10: 为防止误保护, A、B、C 连线应尽可能短。

NOTE 10: To prevent erroneous protection, the wiring of A,B,C should be as short as possible.

备注 11: 保护线路 R4、C3 的时间常数建议选取在 1~2 $\mu$ S。关断时间可能随着布线的不同而多少有些变化。建议 R4、C3 选择小容差, 温度补偿类型。

NOTE 11: The time constant R4、C3 of the protection circuit should be selected in the range of 1.0-2  $\mu$ s. SC interrupting time might vary with the wiring pattern. Tight tolerance, temp-compensated type is recommended for R4, C3.

备注 12: 所有电容的位置尽可能的靠近 IPM。

NOTE 12: All capacitors should be mounted as close to the terminals of the IPM as possible.

备注 13: 为了防止噪声干扰, 储能电容与 P&N1 之间的引线应尽可能的短, 推荐在 P&N1 端子之间加约 0.1~0.22 $\mu$ F 的 MLCC 低频滤波电容。

NOTE 13: To prevent surge destruction, the wiring between the smoothing capacitor and the P, N1 terminals should be as short as possible. Generally, a 0.1-0.22  $\mu$ F snubber between the P-N1 terminals is recommended.

备注 14: VTS 引脚是 IC 内部集成的温度检测输出脚, 如果不需要使用该引脚, 建议用 100K 电阻下拉至 GND, 不允许悬空。

NOTE 14: The terminals of VTS is used to temperature detection, if you don't want to use it, please pull-down the terminal with a 100 K $\Omega$  resistor to GND. No connection is forbidden.

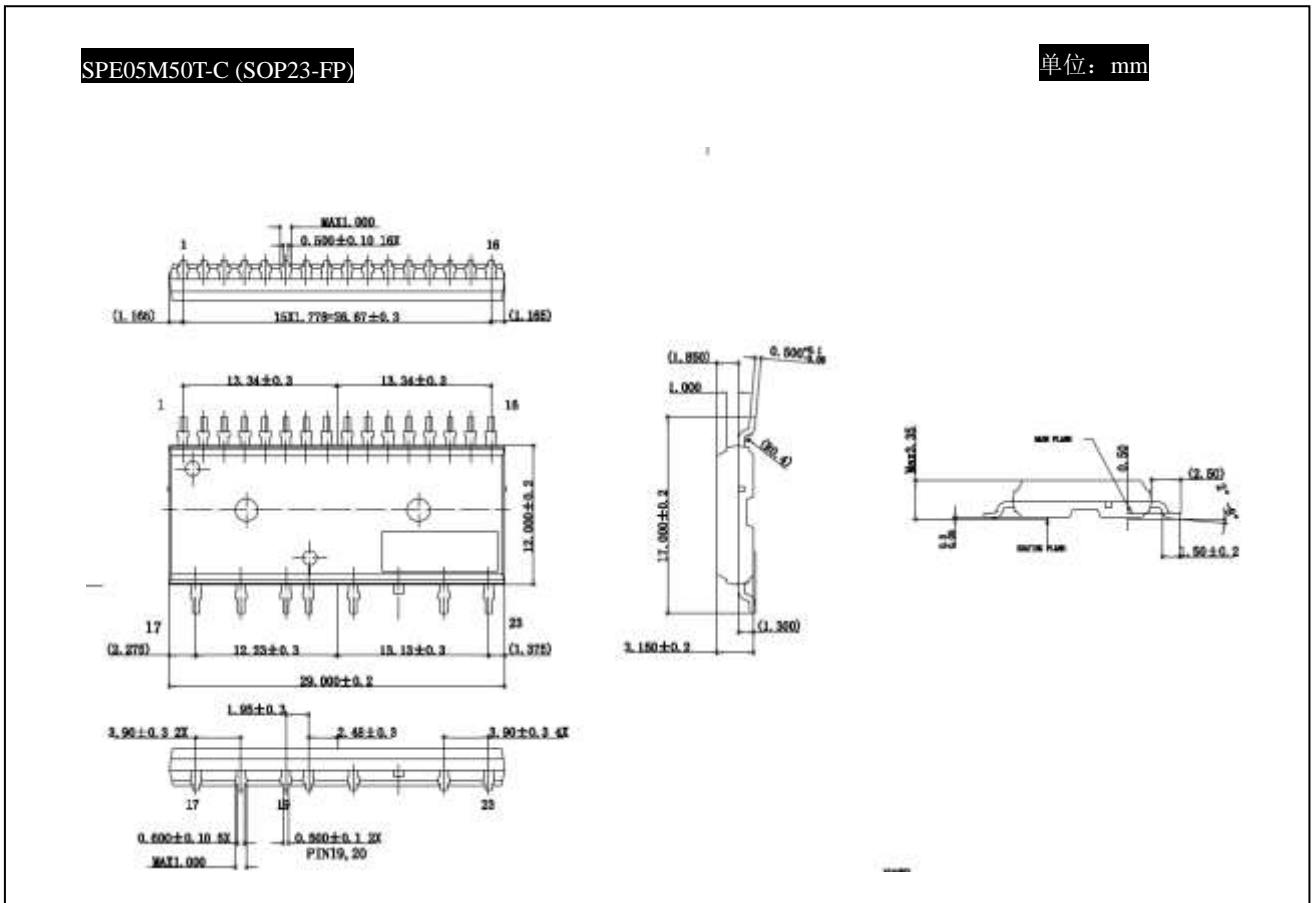


图 11: SPE05M50T-C 封装外形图

Fig 11: SPE05M50T-C Package Outline Drawings



SPE05M50T-A (DIP23-FP)

单位: mm

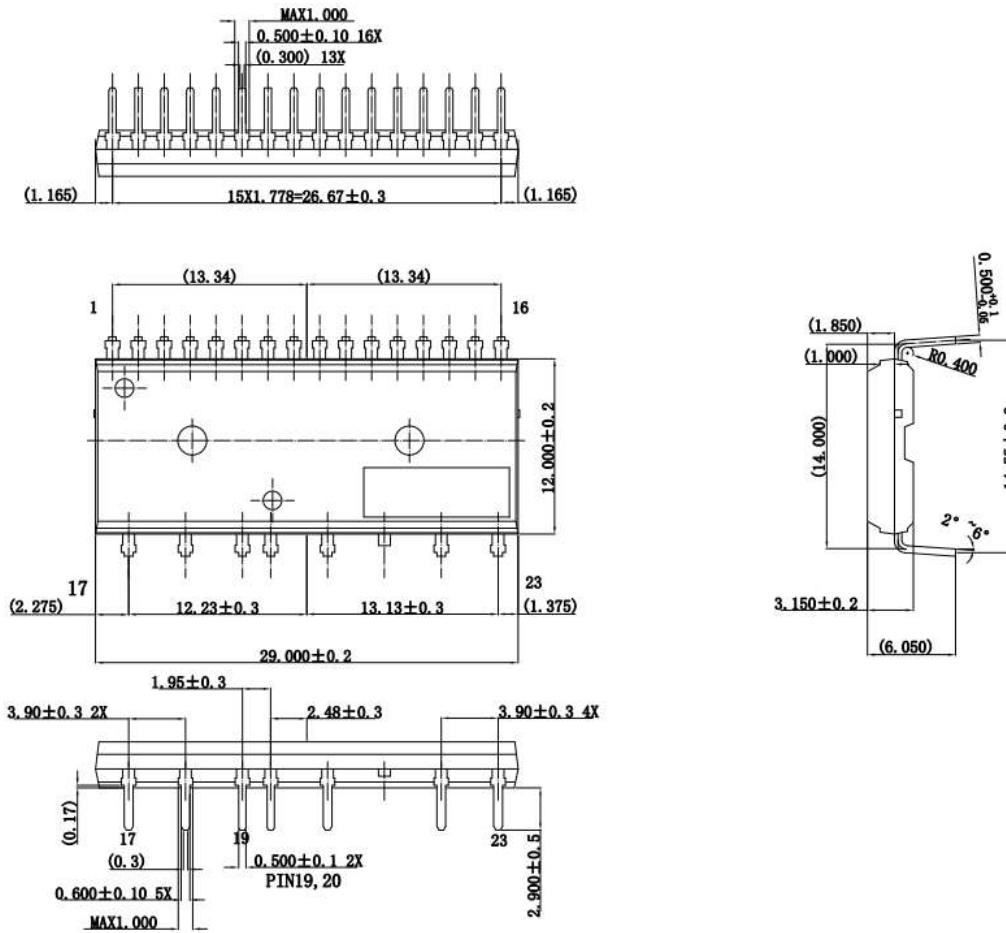


图 12: SPE05M50T-A 封装外形图

Fig 12: SPE05M50T-A Package Outline Drawings



### 注意事项

1. 吉林华微电子股份有限公司的产品销售分为直销和销售代理，无论哪种方式，订货时请与公司核实。
2. 购买时请认清公司商标，如有疑问请与公司本部联系。
3. 在电路设计时请不要超过器件的绝对最大额定值，否则会影响整机的可靠性。
4. 本说明书如有版本变更不另外告知。

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2. We strongly recommend customers check carefully on the trademark when buying our product, if there is any question, please don't be hesitate to contact us.
3. Please do not exceed the absolute maximum ratings of the device when circuit designing.
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